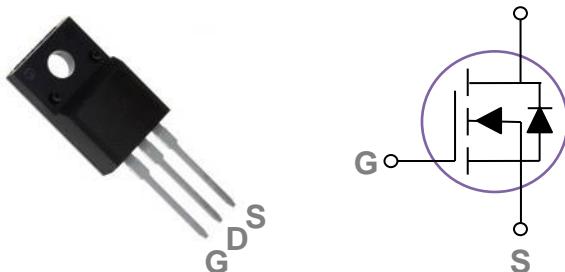


General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

TO220F Pin Configuration



BVDSS	RDS(ON)	ID
100V	4.4mΩ	85A

Features

- 100V, 85A, RDS(ON) = 4.4mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{Gs}	Gate-Source Voltage	+20/-12	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	85	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	54	A
I _{DM}	Drain Current – Pulsed ¹	340	A
EAS	Single Pulse Avalanche Energy ²	378	mJ
I _{AS}	Single Pulse Avalanche Current ²	87	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	66.1	W
	Power Dissipation – Derate above 25°C	0.53	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	1.89	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	100	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =80V, V _{GS} =0V, T _J =85°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =20V, V _{DS} =0V	---	---	100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A	---	3.8	4.4	mΩ
		V _{GS} =4.5V, I _D =15A	---	4.8	6.5	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2	1.8	2.5	V
gfs	Forward Transconductance	V _{DS} =10V, I _D =3A	---	20	---	S

Dynamic and switching Characteristics

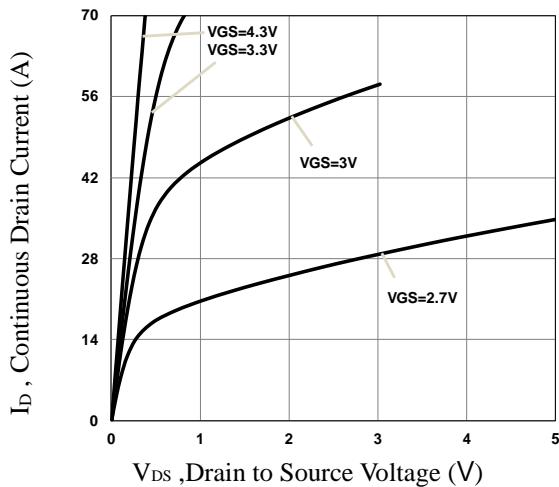
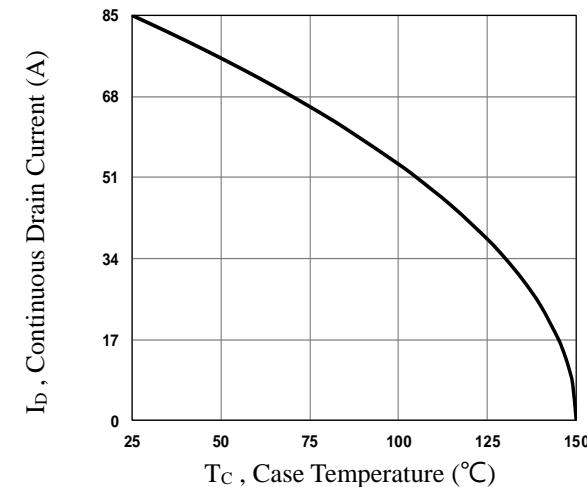
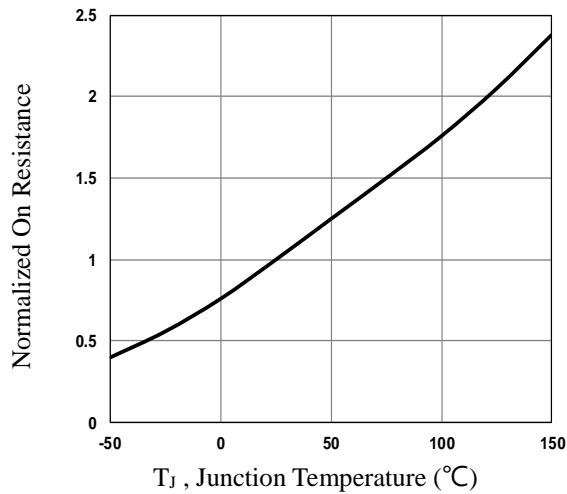
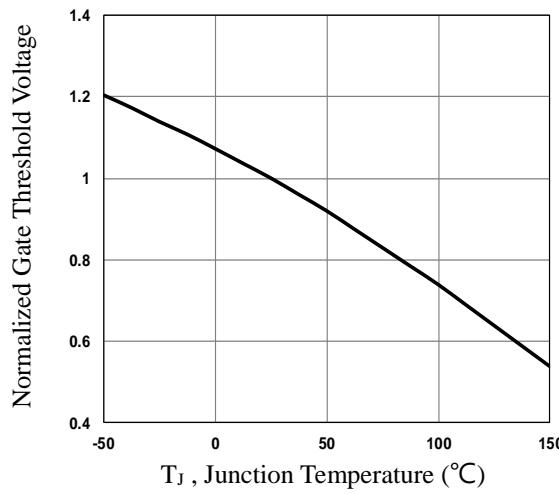
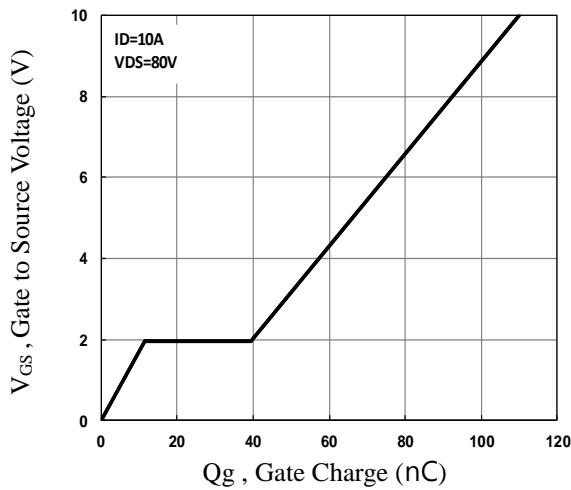
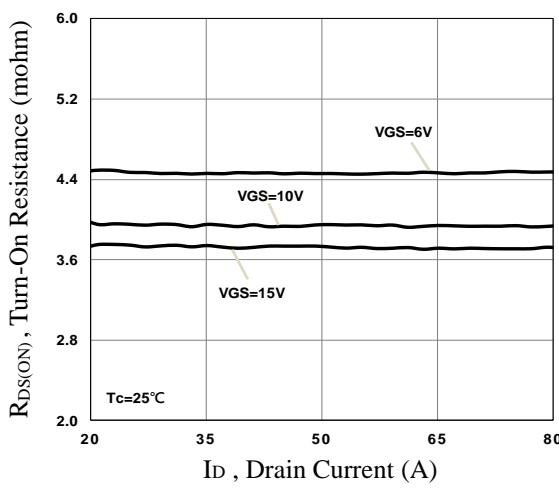
Q _g	Total Gate Charge ^{3, 4}	V _{DS} =50V, V _{GS} =10V, I _D =40A	---	115	173	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	16	24	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	34	51	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =50V, V _{GS} =10V, R _G =6Ω I _D =40A	---	23	35	ns
T _r	Rise Time ^{3, 4}		---	32	48	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	157	236	
T _f	Fall Time ^{3, 4}		---	115	173	
C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, F=1MHz	---	6000	9000	pF
C _{oss}	Output Capacitance		---	1090	1640	
C _{rss}	Reverse Transfer Capacitance		---	27	41	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1.9	---	Ω

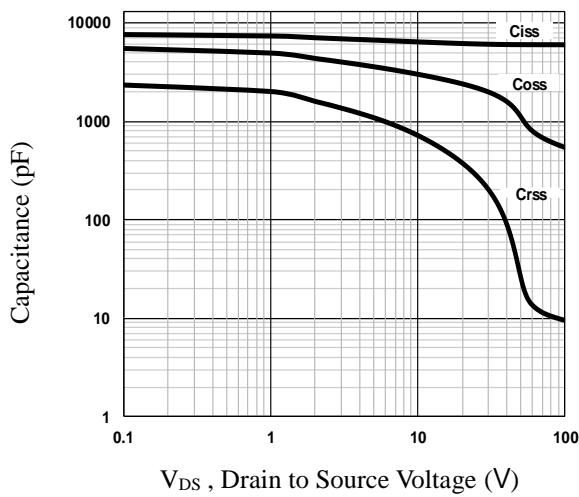
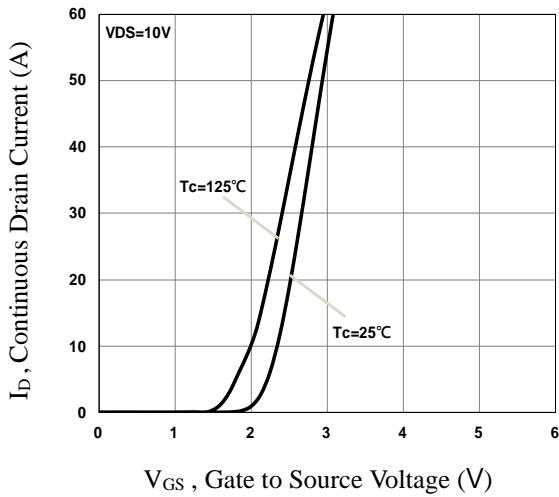
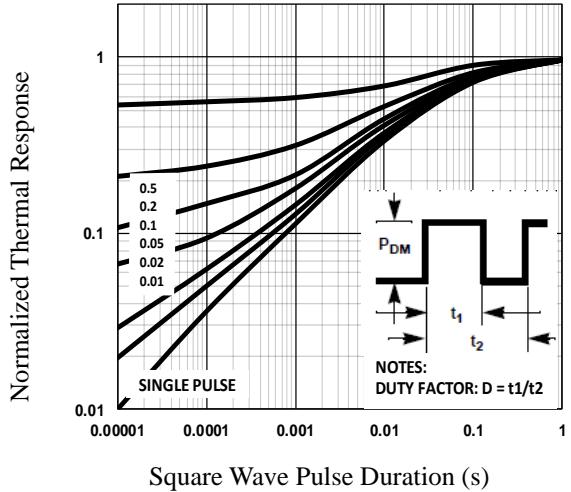
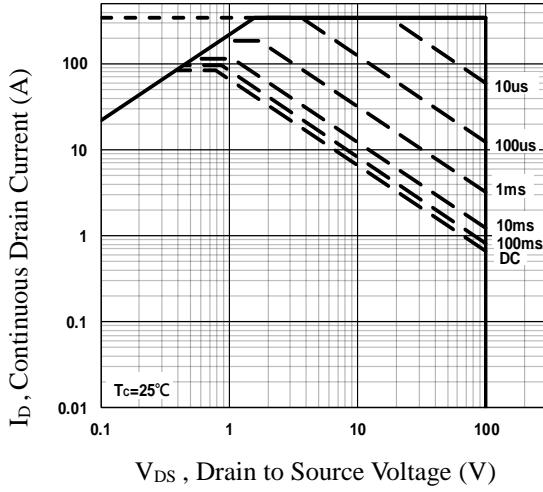
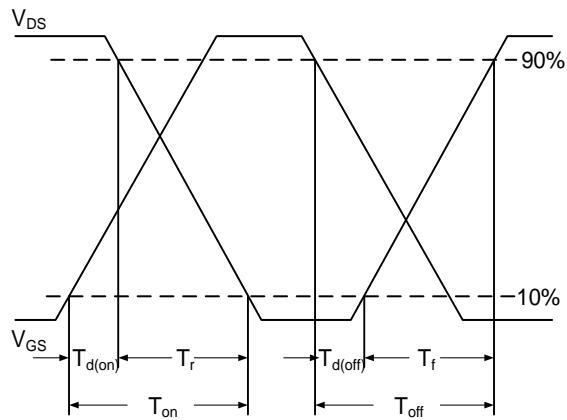
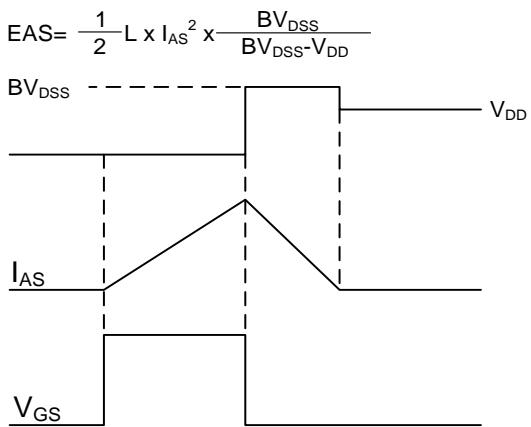
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	85	A
I _{SM}	Pulsed Source Current		---	---	170	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time	V _R =100V, I _S =10A di/dt=100A/μs, T _J =25°C	---	120	---	ns
Q _{rr}	Reverse Recovery Charge		---	310	---	nC

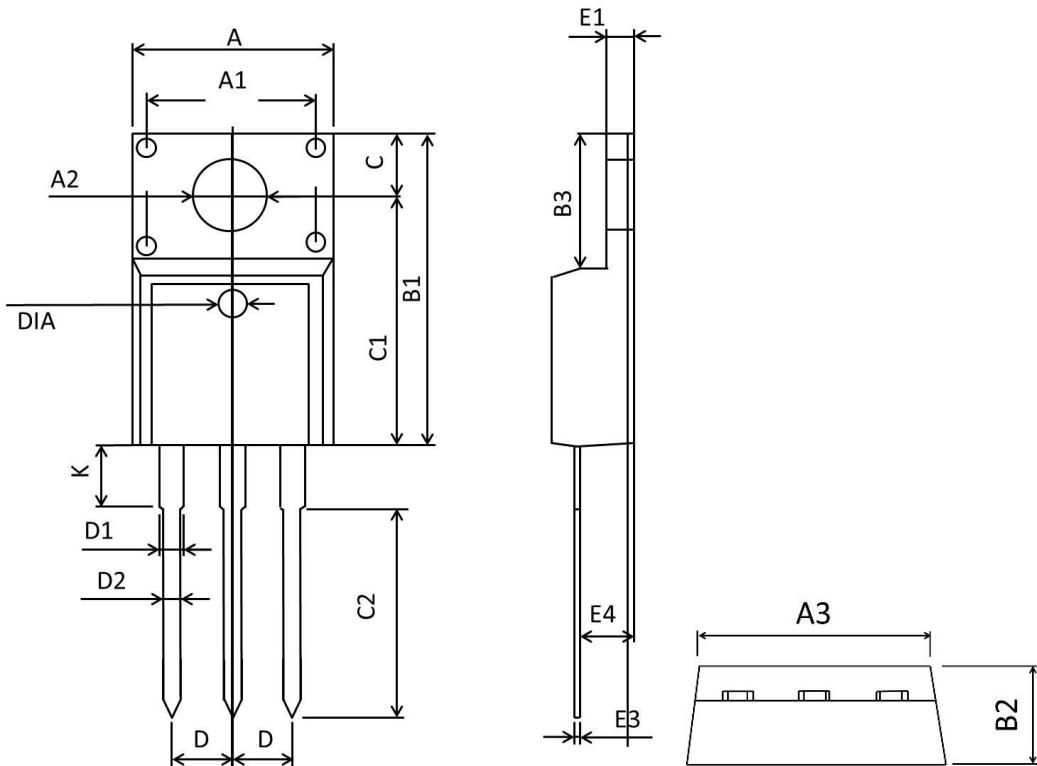
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=87A., R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. Essentially independent of operating temperature.


Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized R_{DSON} vs. T_j

Fig.4 Normalized V_{th} vs. T_j

Fig.5 Gate Charge Characteristics

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Transfer Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 EAS Waveform

TO220F PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	9.860	10.460	0.389	0.411
A1	6.900	7.100	0.272	0.280
A2	3.100	3.500	0.122	0.138
B1	15.450	16.300	0.608	0.642
B2	4.400	5.000	0.173	0.197
B3	6.280	7.100	0.247	0.280
C	3.100	3.500	0.122	0.138
C1	12.270	12.870	0.483	0.507
C2	9.600	10.520	0.378	0.414
D	2.540BSC		0.1BSC	
D1	1.070	1.470	0.042	0.058
D2	0.600	1.000	0.024	0.039
K	2.800	3.500	0.110	0.138
E1	2.340	2.740	0.092	0.108
E3	0.350	0.650	0.014	0.026
E4	2.460	2.960	0.097	0.117
DIA	1.35	1.65	0.053	0.065